

## **AS3490**

# Highly Efficient 2-6 LEDs Backlight Driver with PWM Input

# 1 General Description

The AS3490 is an inductive highly efficient DCDC boost converter. The DCDC converter operates at a fixed frequency of 2MHz and includes soft startup to allow easy integration into noise sensitive RF systems. A predictable startup is guaranteed even with very low duty cycle PWM input signals. The voltage on the output capacitor is controlled to minimize ripple and to avoid any acoustic effects for low frequency PWM input signals.

The output of the DCDC converter is used for five current sources connected to up to 6 LEDs. If a current source is not required, it shall be connected to VOUT or GND - the AS3490 detects this condition and disables this current source automatically; this keeps the efficiency of the system constantly high.

The AS3490 is controlled by one enable input, ON. This input can also be used to connect a PWM input (like DLS or DBC).

The AS3490 includes several protection functions like undervoltage lockout, overcurrent and overtemperature.

No microvias are required to assemble the AS3490.

The AS3490 is available in a space-saving WL-CSP package measuring only 1.7x1.4x0.5mm and operates over the -30°C to +85°C temperature range.

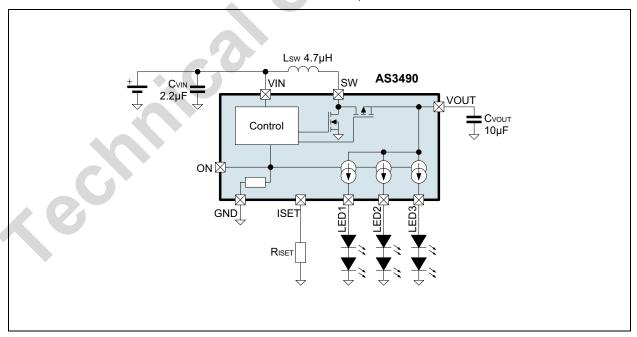
Figure 1. AS3490 Typical Operating Circuit

# 2 Key Features

- 2 MHz DCDC Boost converter
  - Small 4.7µH external coil
  - Very high system efficiency of 86% (DCDC and current sources combined)
  - Very low voltage changes on output to avoid acoustic noise on output capacitor even with PWM
  - Smooth startup even under low duty cycle PWM conditions
- Three Current sources up to 25mA
  - Low voltage compliance (150mV)
  - High side current source to simplify layout and thermal management of the LEDs
  - Automatically detect and disable failing or not used LEDs to keep efficiency high
  - Current matching <4%
  - Current accuracy <7.5%
- Excellent LED current output ripple <500µA
- Support DLS (Dynamic Luminance Scaling or DBC)
- Undervoltage lockout and overcurrent protection
- Overtemperature protection
- Available in a tiny WL-CSP package
  - 3x4 balls, 0.4mm pitch, 1.7x1.4x0.5mm

# 3 Applications

Display backlight driver for mobile phones, digital cameras, PND and PMPs.

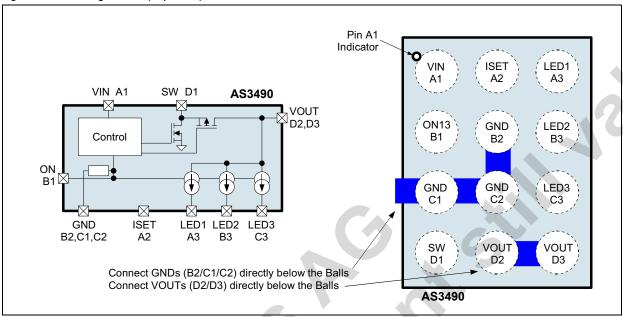




# 4 Pinout

## **Pin Assignment**

Figure 2. Pin Assignments (Top View)



# **Pin Description**

Table 1. WL-CSP12 Pin Description

Pin Number	Pin Name	Description
A1	VIN	Positive supply voltage input - connect to supply and make a short connection to input capacitor CVIN
A2	ISET	External current set resistor, forced to 1.25V in operation - LED current typically 400xISET current
A3	LED1	Current source output 1 - controlled by ON
B1	ON	Digital input pin - enable input active high for current sources D1D3 <sup>1</sup>
B2	GND	Supply ground - connect to ground supply
В3	LED2	Current source output 2 - controlled by ON
C1	GND	Supply ground - connect to supply and make a short connection to input capacitor CVIN and CVOUT
C2	GND	Supply ground - connect to ground supply
C3	LED3	Current source output 3 - controlled by ON
D1	SW	DCDC converter switching node
D2	VOUT	DCDC converter output - make a short connection to capacitor Cout
D3	VOUT	Connect directly to Ball D2

<sup>1.</sup> If ON is low low, the AS3490 enters shutdown.



# 5 Absolute Maximum Ratings

Stresses beyond those listed in Table 2 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Table 3, "Electrical Characteristics," on page 4 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
VIN, ON and ISET to GND	-0.3	+7.0	V	
ON and ISET to VIN		+0.3	V	internal protection diodes to VIN
SW, VOUT, LED1LED3 to GND	-0.3	11	V	746
SW, LED1LED3 to VOUT		+0.3	V	internal protection diodes to VOUT
Input Pin Current without causing latchup	-100	+100 +lin	mA	Norm: EIA/JESD78
Continuous Power Dissipation (T <sub>A</sub> = +70°C)				
Continuous power dissipation		870	mW	P⊤ <sup>1</sup> at Tamb=70°C
Continuous power dissipation derating factor		11.67	mW/°C	PDERATE <sup>2</sup>
Electrostatic Discharge				
ESD HBM		±2000	<b>\</b>	Norm: JEDEC JESD22-A114F
ESD CDM		±500	٧	Norm: JEDEC JESD 22-C101E
ESD MM		±100	٧	Norm: JEDEC JESD 22-A115-B
Temperature Ranges and Storage Condition	ıs			
Junction Temperature		+125	°C	
Storage Temperature Range	-55	+125	°C	
Humidity	5	85	%	Non condensing
Body Temperature during Soldering		+260	°C	according to IPC/JEDEC J-STD-020
Moisture Sensitivity Level (MSL)	MS	SL 1		Represents a max. floor life time of unlimited

<sup>1.</sup> Depending on actual PCB layout and PCB used

<sup>2.</sup> PDERATE derating factor changes the total continuous power dissipation (PT) if the ambient temperature is not 70°C. Therefore for e.g. TAMB=85°C calculate PT at 85°C = PT - PDERATE \* (85°C - 70°C)



# **6 Electrical Characteristics**

VVIN = +2.5V to +5.5V, TAMB =  $-30^{\circ}$ C to  $+85^{\circ}$ C, unless otherwise specified. Typical values are at VVIN = +3.7V, TAMB =  $+25^{\circ}$ C, unless otherwise specified.

Table 3. Electrical Characteristics

Symbol	Parameter	Condition	Min	Тур	Max	Unit
General Ope	erating Conditions					
VVIN	Supply Voltage			3.7	5.5	V
VVIN_REDUC	Supply Voltage reduced performance	not all parameters within specification	2.3			V
Ishutdown	Shutdown Current	ON=0V		0.5	2.0	μA
Ivin	Operating Current	no load, PWM Normal mode		250		μA
Тамв	Operating Temperature		-30	25	85	°C
DCDC Conv	erter parameters					
Vvout	Output Voltage VOUT	automatically regulated	VVIN- 0.3V		VVOUT _MAX	V
		all other conditions with ON13=ON45	C		140	
VVOUT_RIPP LE_PWM	Voltage VOUT due to PWM signal	DCDC not in pulseskip or current limit		70		mV
ILOAD	Load current	VOUT<7.5V	0.0		100	mA
		VVIN=3.7V, TAMB = +25°C,		86		
η	Overall Efficiency	LED mismatch <= 30mV,   ILOAD=75r	nA 85	86		%
		VLED=3.0V ILOAD=100	mA	86		
fclk	Operating Frequency	All internal timings are derived from this oscillator	-10%	2.0	+10%	MHz
tmin_on	Minimum on-time			60		ns
MDC	Maximum Duty Cycle			90		%
Rsw_p	DCDC Switch SW - VOUT			0.5		Ω
Rsw_n	DCDC Switch SW - GND			0.5		Ω
Output volta	age soft start					
tvout_start	softstart time	measured from first high signal on ON		1.2		ms
VVOUT_ START	VOUT startup voltage			7.0		٧
tpwm_start _max	Startup with PWM	Maximum duration between PWM pulse during startup; see Figure 17 on page 1	es 1 10	11	12	ms
tтімеоит	DCDC timeout time	if ON=0 for tTIMEOUT, the DCDC is stopped the AS3490 enters shutdown	and 29		48	ms
Current Sou	irces		<u> </u>		•	
VLED13	LED1LED3 output voltage range		2.6 x2	3.3 x2	3.9 x2	V
ILED13	LED1LED3 output current range		0.0		25.0	mA
ILED13Δ	LED1LED3 current source accuracy <sup>1</sup>	ILED13 =20mA	-7.5		+7.5	%



Table 3. Electrical Characteristics (Continued)

MATCH SILED13 LE RIPPLE LED13 PWMLIN	ED1LED3 current source matching  ED1LED3 ripple current  LED1LED3 linearity <sup>2</sup> VM input frequency  ED1LED3 leakage current	BW=10MHz  ILED=20mA, PWM frequency 300Hz  on pin ON	ILED > 5mA  ILED < 5mA  PWM>=25/255  25/255> PWM>=1/255	-4.0 -2 -10		+4.0 10 500 +2	% of ILED	
RIPPLE  ILED13  PWMLIN	current  LED1LED3 linearity <sup>2</sup> VM input frequency  ED1LED3 leakage	ILED=20mA, PWM frequency 300Hz	ILED < 5mA PWM>=25/255 25/255>			500	ILED	
PWMLIN	LED1LED3 linearity <sup>2</sup> WM input frequency ED1LED3 leakage	PWM frequency 300Hz	PWM>=25/255 25/255>				μA	
PWMLIN	linearity <sup>2</sup> WM input frequency ED1LED3 leakage	PWM frequency 300Hz	25/255>			+2		
PWMLIN	VM input frequency	PWM frequency 300Hz		-10		' -	%	
_	D1LED3 leakage	on pin ON		-10		+10	%	
fpwm PW		•		100	300	800	Hz	
ILED13 LEI LEAKAGE	Current	current source off, TAME	3 < +50°C	-0.5	0	+0.5	μA	
VILED_COMP LE	ED1LED3 current source voltage compliance	Minimum voltage between p		100			mV	
Current Referen	nce (pin ISET)							
VISET	ISET voltage				1.25		V	
ILED2ISET	LED current to ISETcurrent				400		A/A	
Protection Fund	ctions (see page 12			<b>&gt;</b>				
VVOUT_MAX V	OUT overvoltage protection	6				10.0	٧	
VVOUT_OPE \ NLED de	VOUT open LED etection threshold	Voltage level on VOUT where open LED detection is performed			8.5	8.8	٧	
VLED_OPEN	VVLED13 open detection	an open LED is assumed if the voltage on the current source is less than VLED_OPEN and VOUT=VVOUT_OPENLED			92	125	mV	
VLED_SHORT	VLED13 short detection	voltage on LED13 where a shorted LED is assumed			0.95		V	
tLED_ERROR _DEB_OPEN	VLED13 open debounce time	Open LED detection debounce time				4.8	μs	
tLED_ERROR _DEB_SHORT	VLED13 short debounce time	Short LED detection debo	ounce time <sup>4</sup>			9.0	μs	
ILIMIT CU	urrent Limit for coil Lsw (Pin SW)			510	600	685	mA	
TOVTEMP	Overtemperature Protection	Junction tempera	turo		144		°C	
TOVTEMPHY O	Overtemperature Hysteresis	Junction tempera		5		°C		
		Falling V∨ıN			1.9	2.1	٧	
Vuvlo Und	ndervoltage Lockout	Rising VVIN			2.2	2.3	٧	
Digital Interface								
VIH	High Level Input Voltage			1.07		VVIN	٧	
VIL	Low Level Input Voltage			0.0		0.68	V	
RPULLDOWN F	Pulldown resistor		1.8V on pad	90	250		kΩ	

<sup>1.</sup> Excluding variation of external resistor RISET; voltage difference between any set of drivers less than 200mV



- 2. Note: It is not recommended to operate the current sources at minimum duty cycle with low LED currents.
- 3. The dcdc output voltage VOUT is regulated to 150mV above the maximum LED voltage (LED1...LED3) to guarantee proper operation of the current with output voltage ripple and undershoots (e.g. due to PWM or supply voltage changes)
- 4. The short LED detection debounce time is longer than the open LED detection debounce time to allow the parasitic capacitance of the LED to charge above VLED\_SHORT within this time and avoid wrong triggering of short LED detection.



# 7 Typical Operating Characteristics

VBAT = 3.7V,  $T_A = +25$ °C (unless otherwise specified).

Figure 3. DCDC Efficiency vs. VBAT

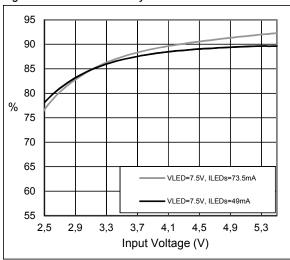


Figure 5. Efficiency vs. Load Current

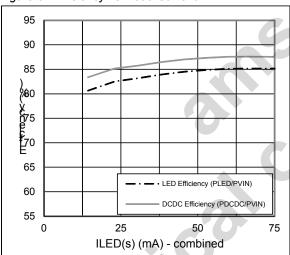


Figure 7. Startup with PWM, 70% duty cycle

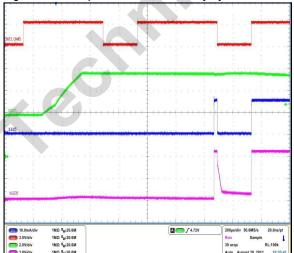


Figure 4. LED Efficiency vs. VBAT

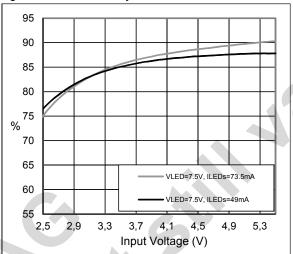


Figure 6. Startup with PWM, 20% duty cycle

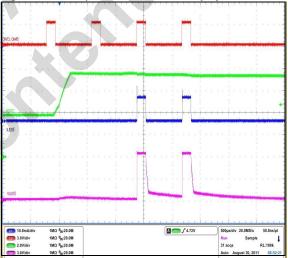


Figure 8. DCDC Switching Waveforms

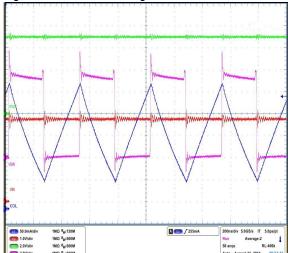




Figure 9. Open LED Detection Waveform

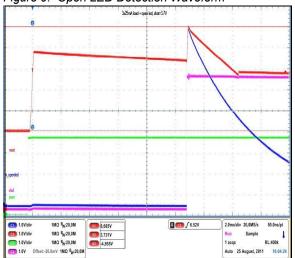


Figure 10. VIN line transient 10µs (ILOAD=100mA)

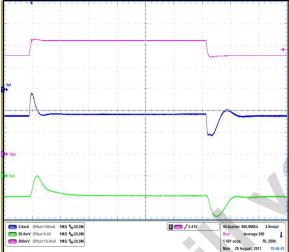


Figure 11. VOUT ripple with PWM



Figure 12. ILED ripple (ILOAD=100mA)

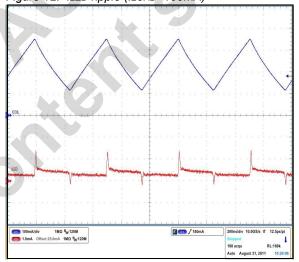


Figure 13. ILED vs. RISET

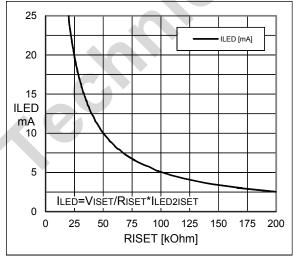


Figure 14. fosc vs.VIN

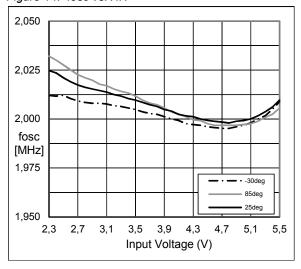
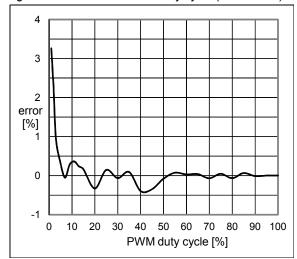




Figure 15. Current Error vs. duty cycle (ILED=25mA)





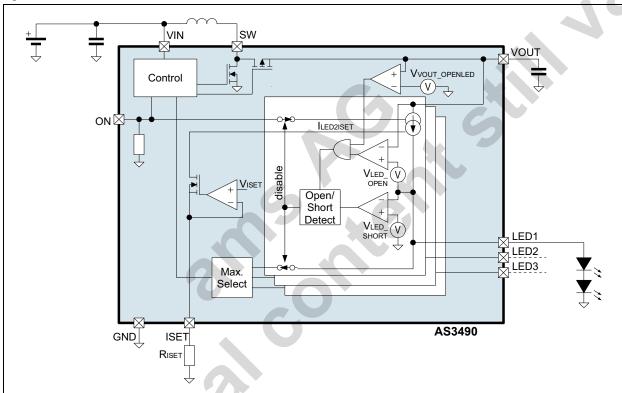
# 8 Detailed Description

The AS3490 is a high performance DCDC step up converter and three current sources in a small WL-CSP12 package. The LED configuration is done in up to three strings<sup>1</sup>, each strings using two LEDs in series<sup>2</sup>. This configuration results in excellent application efficiency even using very small external components (capacitors and coil). The device is controlled by ON. A high levels on this input enables the DCDC and the current sources. ON can be used as PWM input to accurately control the LED brightness.

The target application is to use the AS3490 for highly efficient backlight driver (display and/or keypad backlight).

#### **Internal Circuit**

Figure 16. AS3490 internal circuit



The AS3490 includes a fixed frequency DCDC step-up with accurate startup control. It is enabled by the input pin ON and controls the LED current with five current sources. These input can be used as PWM inputs to control the brightness:

- a high level on ON enables LED1, LED2 and LED3

The current is adjustable by an external resistor RISET.

<sup>1.</sup> Unused strings shall be connected to VOUT or GND.

Single LED strings can be mixed with dual LED strings as long as one string has two LEDs in series - it will reduce application efficiency.

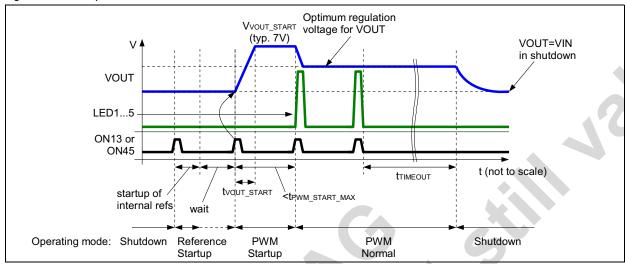
<sup>3.</sup> Using the PWM inputs, the AS3490 supports DLS, dynamic luminance scaling, also called CABC, content adaptive backlight control or DBC, dynamic backlight control.



### **Startup**

In order to avoid inrush-current during startup the supplies are smoothly ramped up according to Figure 17 even under low PWM duty cycle conditions. This allows the easy integration into mobile battery powered systems:

Figure 17. Startup Procedure



## Open and short LED detection

After the startup is finished, the AS3490 continuously monitors open and shorted LEDs. If an open or shorted LED string is detected, this LED string is disabled and the driver continuous its normal operation. The driver is disabled to keep the efficiency of AS3490 for different LED configurations high. The error is cleared once the AS3490 enters shutdown<sup>4</sup>.

#### **Shorted LED**

After startup is finished, for any LED, enabled by the inputs ON, is below VLED\_SHORT, for at least tLED\_ERROR\_DEB\_SHORT, a shorted LED is assumed.

### **Open LED**

LED outputs (LED1...LED5) which are not used by the application shall be connected permanently to VOUT or GND. The AS3490 detect this condition upon startup and automatically disables the current sources for these LEDs - see Figure 18 and Figure 19, immediately after the rising edged of ON.

For LEDs, which are open during operation of the device, following procedure of the AS3490 is used for detection:

After startup is finished, if the voltage on VOUT=VVOUT\_OPENLED<sup>5</sup> and the voltage across any current source, enabled by the inputs ON, is below VLED\_OPEN (VOUT-LED1...3), for at least tLED\_ERROR\_DEB\_OPEN, an open LED is assumed.

Figure 18 shows the waveform for the detection of a single open LED, Figure 19 for all LEDs open.

<sup>4.</sup> The error is automatically cleared as the open/short LED error might be temporarily (e.g. bouncing of the connections to the LED)

If the current limit of the coil (ILIMIT) is reached before VOUT=VVOUT\_OPENLED, an open LED is not detected.



Figure 18. Single Open LED detection

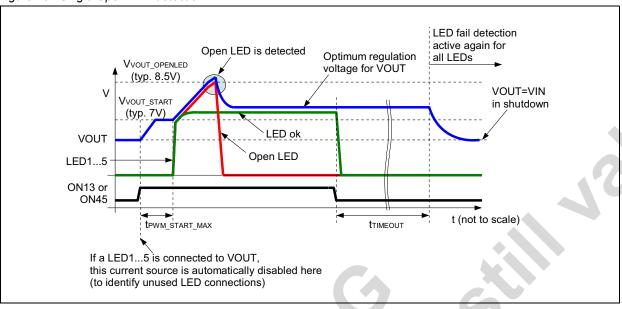
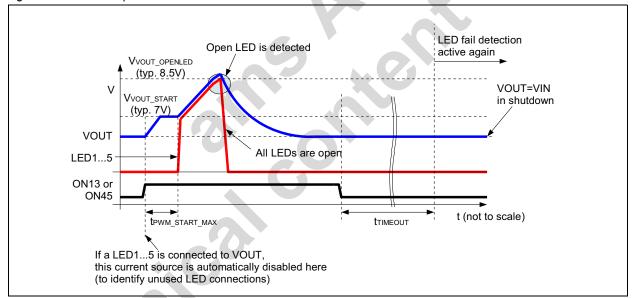


Figure 19. All LEDs open



#### **Protection and Fault Detection Functions**

The protection functions protect the AS3490, its external components and connected LEDs against physical damage.

#### **Overvoltage Protection**

The voltage on VOUT is kept below or at VVOUT\_MAX under every operating condition<sup>6</sup>. If the voltage on VOUT is at VVOUT\_MAX for more than 70ms<sup>7</sup>, the DCDC will shutdown. It can be re-enabled by setting ON to low for more than ttimeout.

<sup>6.</sup> When reaching  $VOUT=VVOUT\_OPENLED$ , the open LED detection is performed.

<sup>7.</sup> The duration can vary from 55ms to 85ms within a single AS3490.



#### **DCDC Inductor Peak Current Limitation**

To limit the maximum current from the battery, the DCDC converter limits its current through the coil to ILIMIT on a cycle by cycle basis.

## **Overtemperature Protection**

The junction temperature of the AS3490 is continuously monitored. If the temperature exceeds Tovtemp, the DCDC is stopped. The driver is automatically re-enabled once the junction temperature drops below Tovtemp-Tovtemphyst.

### **Supply undervoltage Protection**

If the voltage on the pin VIN is or falls below VuvLo, the AS3490 is kept in shutdown.



# 9 Application Information

## **External Components**

#### Input Capacitor CVIN

Low ESR input capacitors reduce input switching noise and reduce the peak current drawn from the battery. Ceramic capacitors are required for input decoupling and should be located as close to the device as is practical.

Table 4. Recommended Input Capacitor

Part Number	С	TC Code	ESR	Rated Voltage	Size	Manufacturer
GRM155R60J225ME15	2.2µF +/-20%	X5R		6V3	0402	Murata
GRM155R60J155MD	1.5µF	X5R		6V3	(1.0x0.5x 0.5mm)	www.murata.com
ECJ0MBFJ185V		X5R			0402 (1.0x0.5x 0.5mm)	Panasonic Matsushita www.panasonic.com
JDK105BJ155MVNF		X5R			0402 (1.0x0.5x 0.5mm)	Taiyo Yuden www.taiyo-yuden.com

If a different input capacitor is chosen, ensure similar ESR value and at least 0.6µF capacitance at the maximum input supply voltage. Larger capacitor values (C) may be used without limitations.

### **Output Capacitors Cout**

Low ESR capacitors should be used to minimize VOUT ripple. Multi-layer ceramic capacitors are recommended since they have low ESR and are available in small footprints. The capacitor should be located as close to the device as is practical.

X5R dielectric material is recommended due to their ability to maintain capacitance over wide voltage and temperature range.

Table 5. Recommended Output Capacitor Couт

Part Number	С	TC Code	ESR	Rated Voltage	Size	Manufacturer
GRM219R61A116UE82L	10µF	X5R	120mΩ	10V	0805 (2x1.25x 0.85mm)	Murata www.murata.com
LDK212BJ106MDNT	10μF	X5R		10V	0805 (2x1.25x 0.85mm)	Taiyo Yuden www.taiyo-yuden.com

If a different output capacitor is chosen, ensure similar ESR values and at least  $4.2\mu F$  @ 5.6V and maximum  $20\mu F$  capacitance.



#### **Inductor Lsw**

The fast switching frequency (2MHz) of the AS3490 allows for the use of small SMDs for the external inductor. The inductor should have low DC resistance (DCR) to reduce the I<sup>2</sup>R power losses - high DCR values will reduce efficiency.

Table 6. Recommended Inductor

Part Number	L	DCR	Size	Manufacturer
LQM2HPN4R7MGC	4.7μH; >2.45μH @ 0.5A	160mΩ	2.5x2.0x0.9mm max height 1.0mm	Murata www.murata.com
CIG32K1R0SAF	4.57μH; >2.45μH @ 0.5A	<300mΩ	2.0x1.25x0.9mm max height 1.0mm	Samsung Electro- Mechancs www.sem.samsung.co.kr

If a different inductor is chosen, ensure similar DCR values and at least 2.45µH inductance at maximum peak input current.

### **PCB Layout Guideline**

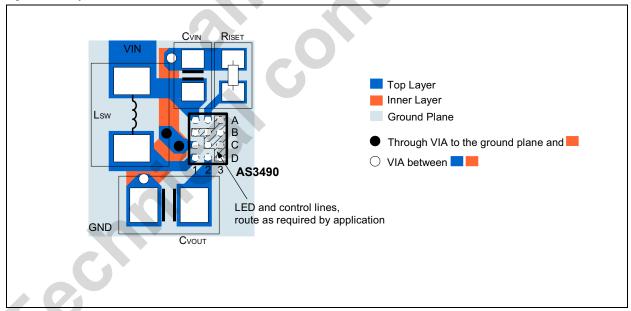
The high speed operation requires proper layout for optimum performance. Route the power traces first and try to minimize the area and wire length of the three high frequency/high current loops:

Loop1: pin GND - CVIN - LSW - pin SW - pin GND

Loop2: pin GND - CVIN - LSW - pin SW - pin VOUT - CVOUT - pin GND

At the pin GND a single via (or more vias, which are closely combined) connects to the common ground plane. This via(s) will isolate the DCDC high frequency currents from the common ground (as most high frequency current will flow between Loop1 and Loop2 and will not pass the ground plane) - see the 'island' at the two through ground vias in Figure 20:

Figure 20. Layout recommendation

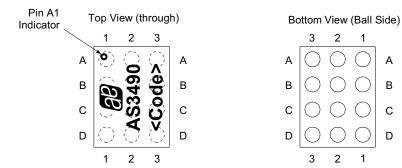


**Note:** If component placement rules allow, move all components close to the AS3490 to reduce the area and length of Loop1 and Loop2



# 10 Package Drawings and Markings

Figure 21. 12pin WL-CSP12 1.7x1.4x0.5mm Marking



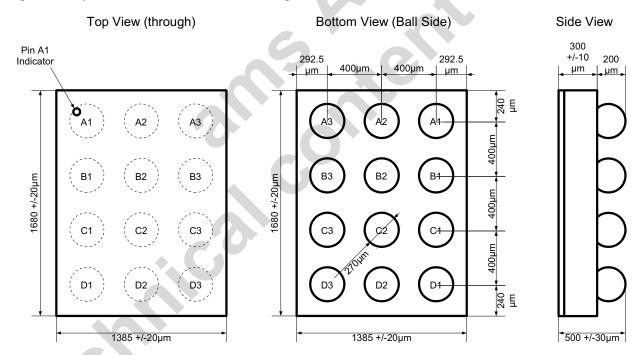
Note:

Line 1: austriamicrosystems logo

Line 2: AS3490 <Code> Line 3:

Encoded Datecode (4 characters)

Figure 22. 12pin WL-CSP12 1.7x1.4x0.5mm Package Dimensions



The coplanarity of the balls is 40µm.



В

С

D





# 11 Ordering Information

The devices are available as the standard products shown in Table 7.

Table 7. Ordering Information

Model	Description	Delivery Form	Package
AS3490-ZWLT	Highly Efficient 2-6 LEDs Backlight Driver with PWM Input	Tape & Reel	12-pin WL-CSP (1.7x1.4x0.5mm) RoHS compliant / Pb-Free / Green

Note: All products are RoHS compliant and austriamicrosystems green.

Buy our products or get free samples online at ICdirect: http://www.austriamicrosystems.com/ICdirect

Technical support is found at http://www.austriamicrosystems.com/Technical-Support

For further information and requests, please contact us mailto:sales@austriamicrosystems.com or find your local distributor at http://www.austriamicrosystems.com/distributor

Note: AS3490-ZWLT

AS3490-

Z Temperature Range: -30°C - 85°C

WL Wafer Level Chip Scale Package (WL-CSP) 1.7x1.4x0.5mm

T Delivery Form: Tape & Reel



### Copyrights

Copyright © 1997-2012, austriamicrosystems AG, Schloss Premstaetten, 8141 Unterpremstaetten, Austria-Europe. Trademarks Registered ®. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

All products and companies mentioned are trademarks or registered trademarks of their respective companies.

#### **Disclaimer**

Devices sold by austriamicrosystems AG are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. austriamicrosystems AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. austriamicrosystems AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with austriamicrosystems AG for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by austriamicrosystems AG for each application. For shipments of less than 100 parts the manufacturing flow might show deviations from the standard production flow, such as test flow or test location.

The information furnished here by austriamicrosystems AG is believed to be correct and accurate. However, austriamicrosystems AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of austriamicrosystems AG rendering of technical or other services.



### **Contact Information**

#### Headquarters

austriamicrosystems AG

Tobelbaderstrasse 30 Schloss Premstaetten A-8141 Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

For Sales Offices, Distributors and Representatives, please visit:

http://www.austriamicrosystems.com/contact